

MODEL NO. : _	TM023KDH19
ISSUED DATE: _	2010-05-22
VERSION .	Vor 1.0

■Preliminary Specification
□Final Product Specification

Customer:

Approved by	Notes

SHANGHAI TIANMA Confirmed:

Prepared by	Checked by	Approved by

This technical specification is subjected to change without notice

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Record of Revision

Rev	Issued Date	Description	Editor
1.0	2010-05-22	Preliminary Release	Jianchuan Wang
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2			



1 General Specifications

	Feature	Spec	
	Size	2.30 inch	
	Resolution	320(RGB) x 240	
	Interface	CPU 8/16 bits	
	Color Depth	65K/262K	
	Technology Type	a-Si	
Display Spec	Pixel Pitch (mm)	0.1461x 0.1461	
	Pixel Configuration	R.G.B Vertical Stripe	
	Display Mode	TM with Normally White	
	Surface Treatment(Up Polarizer)	Clear Type (3H)	
	Viewing Direction	6 o'clock	
	Gray Scale Inversion Direction	12 o'clock	
	LCM (W x H x D) (mm)	50.90x45.80x2.25	
Machaniaal	Active Area(mm)	46.752x35.064	
Mechanical Characteristics	With /Without TSP	Without TSP	
	Weight (g)	8.44	
	LED Numbers	4 LED	
Electronic	Driver IC	ILI9342	

Note 1:Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift.

Note 2 : Requirements on Environmental Protection: Q/S0002

Note 3: LCM weight tolerance: \pm 5%



2 Input/Output Terminals

2.1 TFT LCD Panel

No	Symbol	I/O	Description	Remark
1	LEDK	Р	LED Cathode	
2	LEDA4	Р	LED Anode	
3	LEDA3	Р	LED Anode	
4	LEDA2	Р	LED Anode	
5	LEDA1	Р	LED Anode	
6	GND	Р	Power Ground	
7	RESET	I	Input RESET signal	
8	DB15		Data Bus	
9	DB14	I	Data Bus	
10	DB13	I	Data Bus	
11	DB12	I	Data Bus	
12	DB11	I	Data Bus	
13	DB10		Data Bus	
14	DB9		Data Bus	
15	DB8	U	Data Bus	
16	DB7		Data Bus	
17	DB6	_	Data Bus	
18	DB5	_	Data Bus	
19	DB4	I	Data Bus	
20	DB3	I	Data Bus	
21	DB2	I	Data Bus	
22	DB1	I	Data Bus	
23	DB0	I	Data Bus	
24	IM0	I	Mode select	

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25	RD	I	A read strobe signal and enables an operation to read out data when the signal is low.	
26	WR	ı	A write strobe signal and enables an operation to write data when the signal is low.	
27	RS	I	A register select signal	
28	CS	I	A chip select signal	
29	IOVCC	Р	IO Pad and Digital power supply	
30	VCC	Р	Analog power supply	
31	VCI	Р	Analog power supply	
32	GND	Р	Power Ground	
33	NC		Not Connected	
34	NC		Not Connected	
35	NC		Not Connected	
36	NC		Not Connected	

Table 2.1 input terminal pin assignment

Note2-1: I/O definition:

I-----Input O---Output P----Power/ Ground NC--- Not Connected

IMO	Interface	DB pin
0	8 bit	DB0~DB7
1	16bit	DB0~DB15

Table 2.2 8/16 bit selection pin



3 Absolute Maximum Ratings

3.1 Driving TFT LCD Panel

 $Ta = 25^{\circ}C$

Item	Symbol	Min	Max	Unit	Remark
Logic Supply Voltage	IOVCC	-0.3	3.6	٧	
Analog Supply Voltage	VCI/VCC	-0.3	4.8	V	
Input Signal Voltage	DB0~DB15, IM0,WR, RS,CS,RESET,RD	-0.3	IOVCC +0.3	V	
Back Light Forward Current	I _{LED}	7	25	mA	
Operating Temperature	T _{OPR}	-20	70	$^{\circ}$ C	
Storage Temperature	T _{STG}	-30	80	$^{\circ}$	

4 Electrical Characteristics

4.1 Driving TFT LCD Panel

GND=0V, Ta=25℃

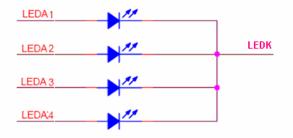
Iter	Item		Min	Тур	Max	Unit	Remark
Logic Supp	ly Voltage	IOVCC	1.65	1.8	3.3	V	
Analog Supp	oly Voltage	VCI	2.3	2.8	4.8	V	
Input Signal	Low Level	VIL	GND	1	0.2xIOVCC	٧	DB0~DB15, WR,
Voltage	High Level	VIH	0.8xIOVCC	1	IOVCC	٧	IM0,RD,RS,CS,RESET
Output Signal	Low Level	Vol	GND	1	0.2xIOVCC	>	
Voltage	High Level	V _{ОН}	0.8xIOVCC		IOVCC	٧	
(Panel+ LSI) Power Consumption		Black Mode (60Hz)				mW	
		Sleeping Mode		ì	-	mW	

Note: We will provide the power consumption after we test the samples.

4.2 Driving Backlight Ta=25℃

Item	Symbol	Min	Тур	Max	Unit	Remark
Forward Current	<u>_</u>		15	25	mA	
Forward Voltage	V_{F}		3.2		V	4 LEDo in parallal
Power Consumption	W_{BL}		192		mW	4 LEDs in parallel

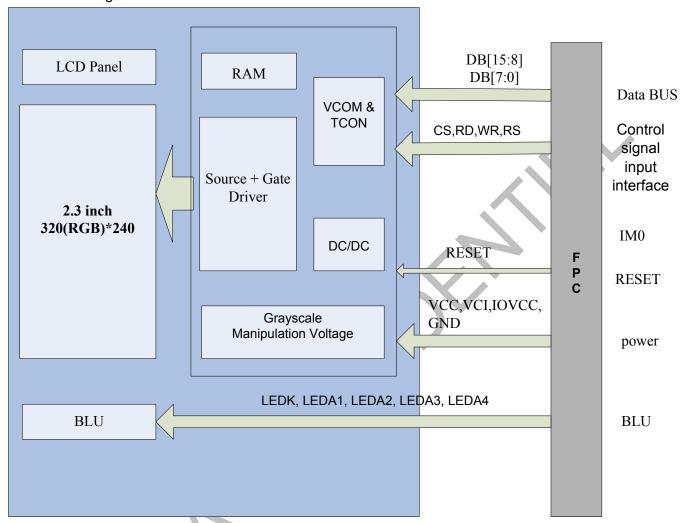
Note1: Figure below shows the connection of backlight LED.



Note 2: One LED: $I_F = 15$ mA, $V_F = 3.2V$



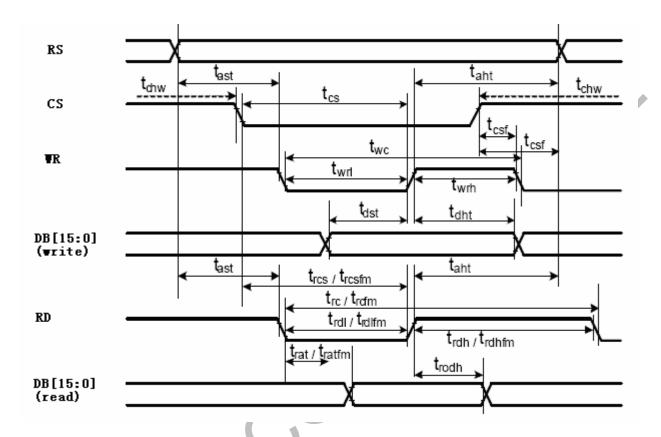
4.3 Block Diagram





5 Timing Chart

5.1 Interface Characteristics



5.2 Interface Timing Parameters

Normal Write Mode

Nominary	vrite wode						
Signal	Symbol	Parameter		Spec		Description	
Signal			Min	Max	Unit	Description	
RS	t_{AST}	Address setup time	0		20		
	t_{AHT}	Address hold time(Write/Read)	10	-	ns	-	
	t _{CHW} Chip select "H" pulse width		0				
	t _{cs}	Chip select setup time (Write)	15				
	t _{RCS}	Chip select setup time (Read	45	- ns			
CS	•	ID)				_	
03	t _{RCSFM}	Chip select setup time (Read	355	_	113	-	
		FM)					
	t_{CSF}	Chip select wait	10				
		time(Write/Read)					
WR	t_WC	Write cycle	65				
VVIX	t_WRH	Control pulse "H" duration	15	-	ns	-	
	t_{WRL}	Control pulse "L" duration					
RD (ID)	t_RC	Read cycle (ID)	160		ns	When read ID data	
ND (ID)	t _{RDH}	Control pulse "H" duration (ID)	90	_	115	Wileli leau ID dala	

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	t_{RDL}	Control pulse "L" duration (ID)	45			
	t _{RCFM}	Read cycle (FM)	450			
RD(FM)	t _{RDHFM}	Control pulse "H" duration	90		ns	When read from
		(FM)		_	113	frame memory
	t _{RDLFM}	Control pulse "L" duration (FM)	355			
	t _{DST}	Data setup time	10	-		For maximum
DB[15:0],	t _{DHT}	Data hold time	10	-		C _L =30pF
DB[13.0],	t _{RAT} Read access time (ID)		-	40	ns	For minimum
	t _{RATFM}	Read access time (FM)		340		C _L =8pF
	t _{odh}	Output disable time	20	80		OL-obi

Table 5.2 CPU Interface Timing Parameters

5.3 Interface Register write/read timing

5.3.1 System Bus Interface Register or GRAM Write Timing

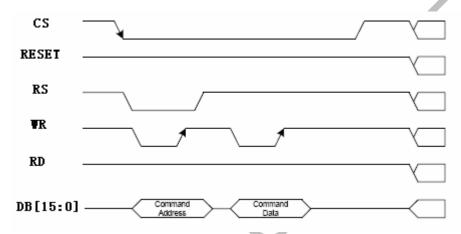


Figure 5.3.1 System Bus Interface Register or GRAM Write Timing

5.3.2 System Bus Interface Register or GRAM Read Timing

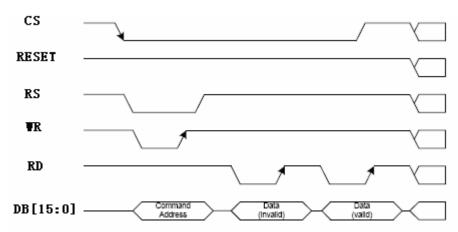


Figure 5.3.1 System Bus Interface Register or GRAM Read Timing

5.4 GRAM Write/Read Data Format

5.4.1 Write data for RGB 5-6-5 (65k colors) bits input in 8-bit parallel Interface

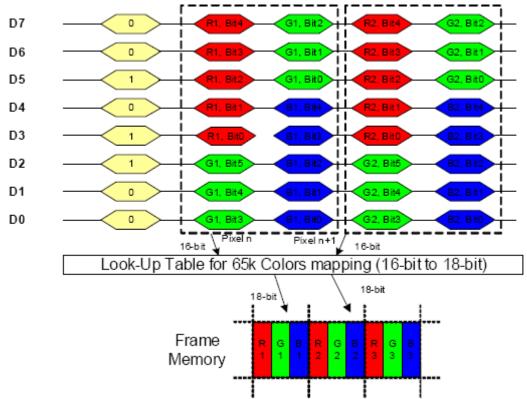


Figure 5.4.1 Write data for RGB 5-6-5 (65k colours) bits input in 8-bit parallel Interface

Write data for RGB 6-6-6 (262k colours) bits input in 8-bit parallel Interface

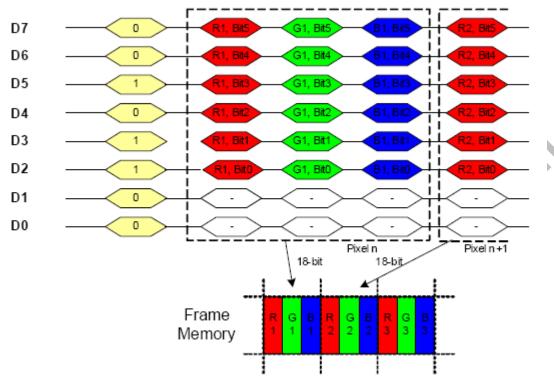


Figure 5.4.2 Write data for RGB 6-6-6 (262k colours) bits input in 8-bit parallel Interface

5.4.3 Write data for RGB 5-6-5 (65k colors) bits input in 16-bit parallel Interface

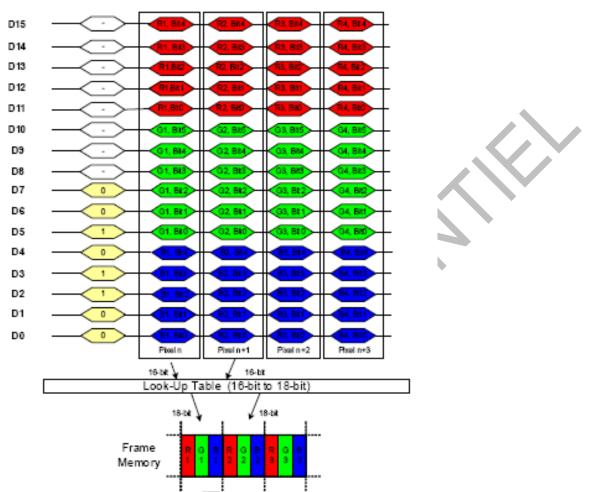


Figure 5.4.3 Write data for RGB 5-6-5 (65k colors) bits input in 16-bit parallel Interface

5.4.4 Write data for RGB 6-6-6 (262k colors) bits input in 16-bit parallel Interface

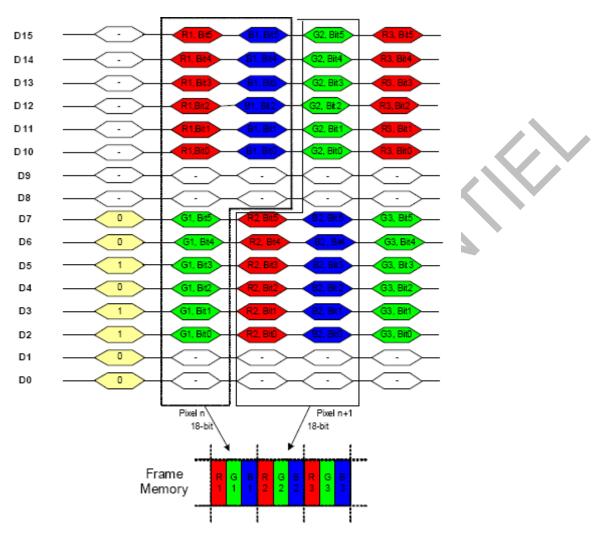


Figure 5.4.4 Write data for RGB 6-6-6 (262k colors) bits input in 16-bit parallel Interface

5.5 Reset Timing Characteristics

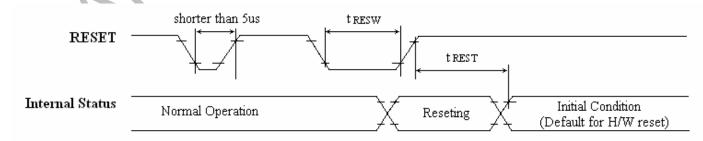


Figure 5.6.1 Reset Input Timing

Symbol	Parameter	Related	Spec.		Note	Unit	
Syllibol	raiailletei	Pins	Min.	Тур.	Max.	Note	Oilit
t _{RESW}	Reset low pulse	RESET	10	-	-	-	us



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	width						
	Reset complete	-	-	1	5	When reset applied during "Sleep In mode"	ms
T REST	time	-		-	120	When reset applied during "Sleep Out mode"	ms

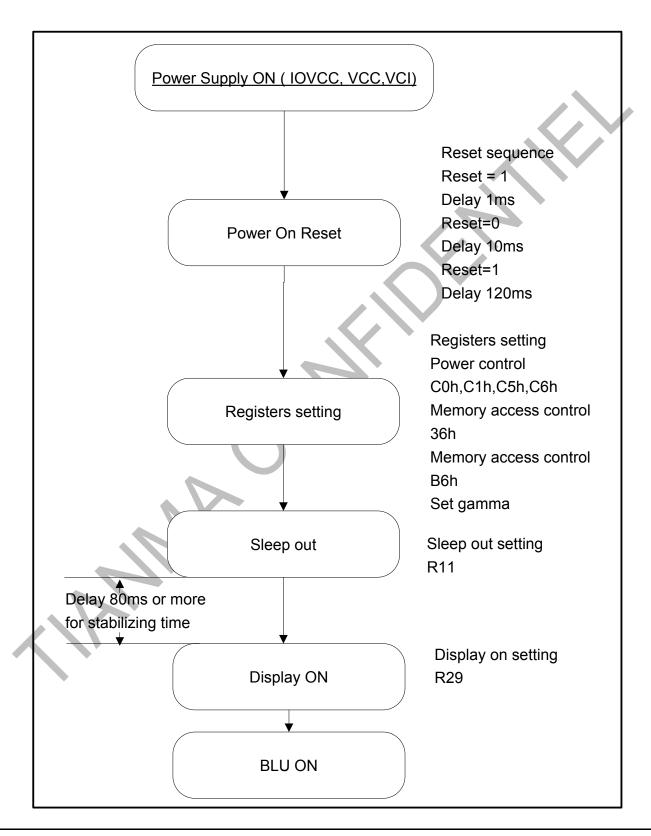
Table 5.6 Reset Timing Parameters

Note 1:

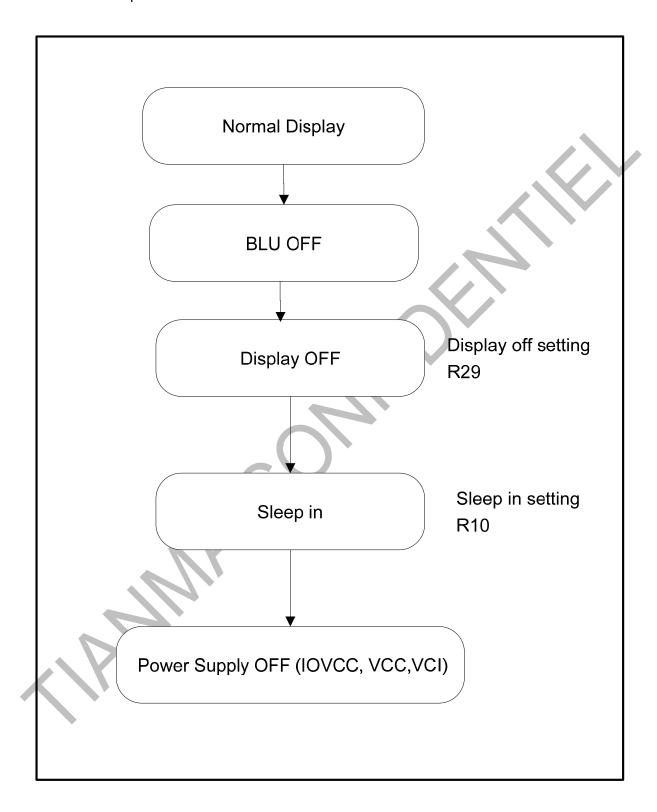
١.	
RESET Pulse	Action
Shorter than 5µs	Reset Rejected
Longer than 10µs	Reset
Between 5µs and 10µs	Reset Start

Power On/Off Sequence

6.1 Power on Sequence



6.2 Power Off Sequence





7 Optical Characteristics

Ta=25°C

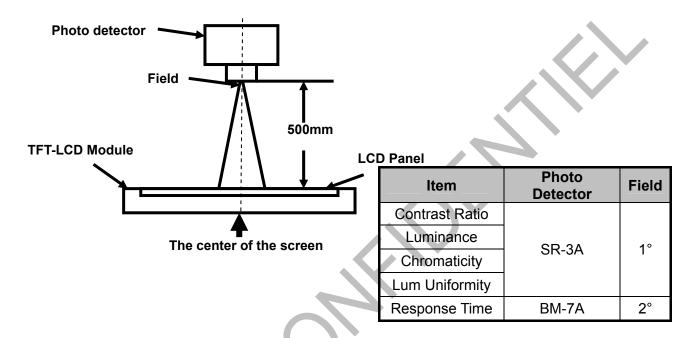
Item		Symbol	Condition	Min	Тур	Max	Unit	Remark
		θТ		60	70	-		
Viou And	View Angles		CR≧10	50	60	-	Dograd	Note 2
view Ang	jies	θL	UN≦ IU	60	70	-	Degree	Note 2
		θR		60	70	-		
Contrast F	Ratio	CR	θ=0°	400	500	-		Note1 Note3
Response	Time	Ton	25 ℃		20	30	ms	Note1
Response	Tillie	Toff	25 (_	20	30	1113	Note4
	White	х		0.247	0.297	0.347		
	VVIIILE	у	Backlight is	0.263	0.313	0.363		
	Red	X		0.536	0.586	0.636		
Chromaticity		у		0.292	0.342	0.392		Note5,
Ciliomaticity	Green	х	on	0.288	0.338	0.388		Note1
		у		0.518	0.568	0.618		
	Blue	х		0.098	0.148	0.198		
	Dide	у		0.032	0.082	0.132		
Uniform	ity	U		ı	80	-	%	Note1 Note6
NTSC				-	50	-	%	Note 5
Luminar	ice	L		200	250	-	cd/m ²	Note1 Note7

Test Conditions:

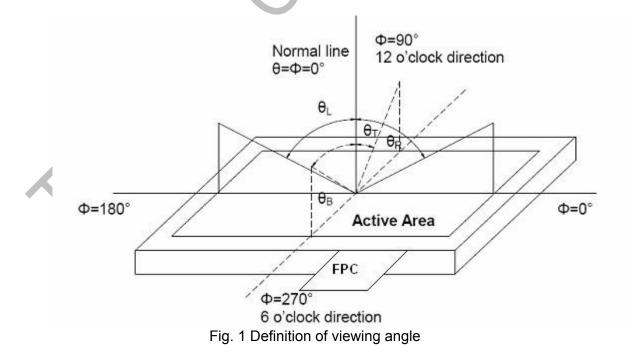
- 1. $V_F=3.2V$, $I_F=15mA$, the ambient temperature is 25° C.
- 2. The test systems refer to Note 1 and Note 2.

Note 1: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 5 minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.



Note 2: Definition of viewing angle range and measurement system. viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).



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Note 3: Definition of contrast ratio

Contrast ratio (CR) = Luminance measured when LCD is on the "White" state

Luminance measured when LCD is on the "Black" state

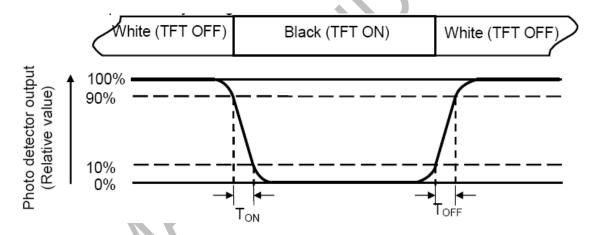
"White state ": The state is that the LCD should driven by Vwhite.

"Black state": The state is that the LCD should driven by Vblack.

Vwhite: To be determined Vblack: To be determined.

Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (TON) is the time between photo detector output intensity changed from 90% to 10%. And fall time (TOFF) is the time between photo detector output intensity changed from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.

Note 6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity(U) = Lmin/Lmax

L----- Active area length W---- Active area width

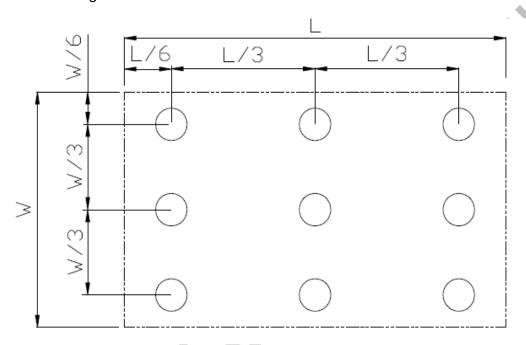


Fig. 2 Definition of uniformity

Lmax: The measured maximum luminance of all measurement position.

Lmin: The measured minimum luminance of all measurement position.

Note 7: Definition of Luminance:

Measure the luminance of white state at center point.



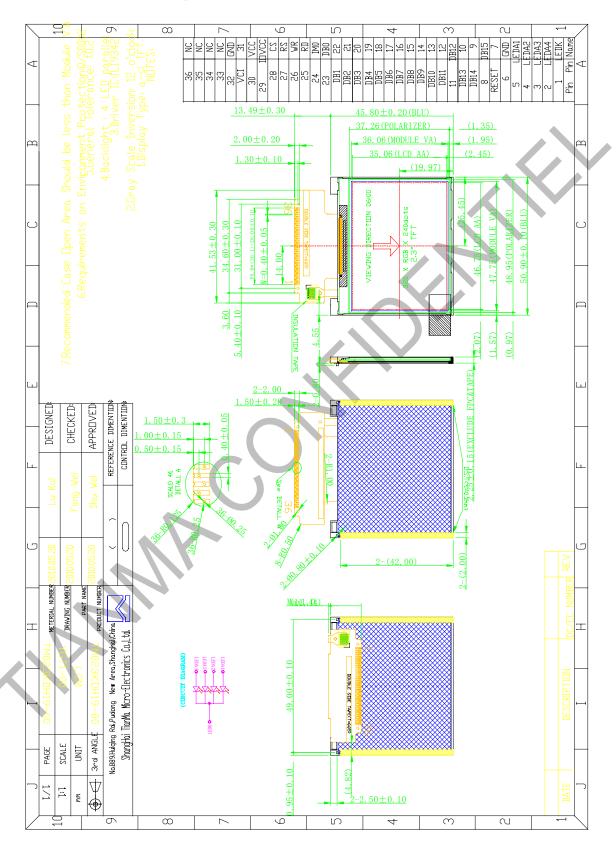
8 Environmental / Reliability Tests

No	Test Item	Condition	Remarks
1	High Temperature Operation	Ts=+70℃, 48hrs Restore4H at 25℃	Note1 IEC60068-2-1,GB2423.2
2	Low Temperature Operation	Ta=-20℃, 48hrs Restore4H at 25℃	IEC60068-2-1 GB2423.1
3	High Temperature Storage	Ta=+80℃, 96hrs Restore4H at 25℃	IEC60068-2-1 GB2423.2
4	Low Temperature Storage	Ta=-30℃, 96hrs Restore4H at 25℃	IEC60068-2-1 GB2423.1
5	High Temperature & High Humidity Storage		Note2 IEC60068-2-78 GB/T2423.3
6	Thermal Shock (Non-operation)	-30°C 30 min~+80°C 30 min, Change time:5min, After 10 cycle, Restore4H at 25°C	Start with cold temperature, End with high temperature, IEC60068-2-14,GB2423.22
7	Vibration (Non-operation)	Frequency range:10~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 1 hours for each direction of X.Y.Z.(3 hours for total)	IEC61000-4-2 GB/T17626.2
8	Package Drop Test	Height:80 cm, 1 corner, 3 edges, 6 surfaces	IEC60068-2-6 GB/T2423.10

Note1: Ts is the temperature of panel's surface.

Note2: Ta is the ambient temperature of sample.

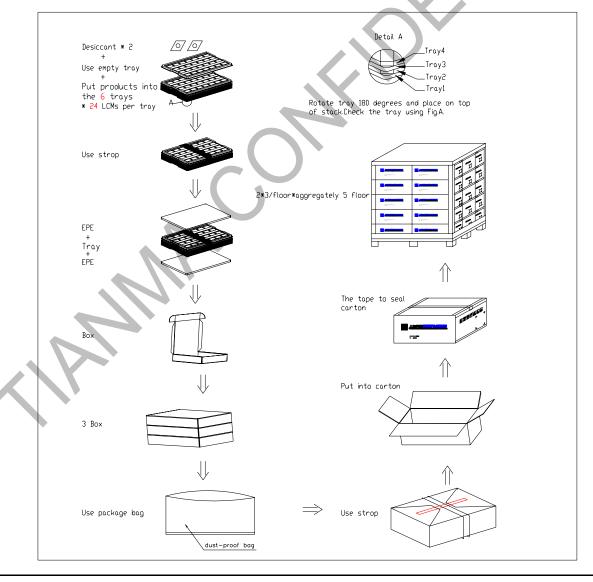
9 Mechanical Drawing





10 Packing Drawing

No	Item	Model(Material)	Dimensions(mm)	Unit Weight(Kg)	Quantity	Remark			
1	LCM module	TM023KDH19-00	51×45.8×2.25	0.00844	576				
2	Tray	PET (Transmit)	315×247×10.8	0.086	54	Anti-static			
3	EPE	EPE	315×247×5	0.009	12				
4	Anti-Static Bag	PE	700×540	0.021	1				
5	BOX	Corrugated Paper	345×260×70	0.227	6				
6	Desiccant	Desiccant	45×50	0.0035	12				
7	Carton	Corrugated Paper	544×365×250	1.01	1				
8	Total Weight(Kg)		12.048						





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11 Precautions for Use of LCD Modules

- 11.1 Handling Precautions
- 11.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 11.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 11.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 11.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 11.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol、
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 11.1.6 Do not attempt to disassemble the LCD Module.
- 11.1.7 If the logic circuit power is off, do not apply the input signals.
- 11.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
- 11.1.8.1 Be sure to ground the body when handling the LCD Modules.
- 11.1.8.2 Tools required for assembly, such as soldering irons, must be properly ground.
- 11.1.8.3 To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
- 11.1.8.4 The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.
 - 11.2 Storage precautions
- 11.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 11.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0° C \sim 40 $^{\circ}$ C Relatively humidity: ≤80%

- 11.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
 - 11.3 Transportation Precautions:

The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.